CBM-120

Mosaic Array Series

Ultraviolet Chip On Board LEDs

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Features:

- Mosaic Array UV LED chipset with surface emitting area of 12 mm^2, 4:3 aspect ratio
- All the benefits of chip on board processing without the need for complicated assembly process
- Vertical chip UV LED technology for high power density and uniform emission
- Wide Range of UVA Wavelengths
- High thermal conductivity copper coreboard package
- Low-profile window for efficient coupling into small-etendue systems
- Can be operated at variable drive currents up to 18A
- NIST traceable optical and electrical measurement testing
- Environmentally friendly: RoHS and Halogen compliant

Applications

- Curing:
  - › Inks
  - › Coatings
  - › Adhesives
- Inspection
- Machine Vision
- Fiber-coupled illumination
- Specialty Projection Systems for Maskless Lithography:
  - › Optically matched to TI 0.95"DMD
- Rapid Prototyping and 3D printing
- Medical and Scientific Instrumentation

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Technology Overview

Luminus LEDs benefit from innovations in device technology, chip packaging and thermal management. This suite of technologies give engineers and system designers the freedom to develop solutions both high in power and efficiency.

Luminus Mosaic Array LED Technology

Luminus' Devices vertical chip LED technology enables LED chips with uniform brightness over the entire LED chip surface. The optical power and brightness produced by these densely packed arrays of devices enable solutions not possible with single chip packages that be used to replace arc and halogen lamps.

Packaging Technology

Thermal management is critical in high power LED applications. With a thermal resistance from junction to heat sink of 0.6 °C/W, Luminus CBM-120 LEDs have the lowest thermal resistance of any UV LED on the market. This will allow the LEDs to be driven at higher current densities while maintaining a low junction temperature, thereby resulting in brighter solutions and longer lifetimes.

Reliability

With designs based on years of chip and packaging development experience, Luminus LEDs are one of the most reliable light sources in the world today. Luminus LEDs pass a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity, and have been fully qualified for use in extreme high power and high current applications. With very low failure rates and median lifetimes that typically exceed 30,000 hours, Luminus UV LEDs are ready for even the most demanding applications.

Environmental Benefits

Luminus LEDs help reduce power consumption and the amount of hazardous waste entering the environment. All LED products manufactured by Luminus are RoHS and Halogen compliant and free of hazardous materials, including lead and mercury.

Understanding Mosaic Array UV LED Test Specifications

Every Luminus LED is fully tested to ensure that it meets the high quality standards expected from Luminus' products.

Testing Temperature

Luminus core board products are typically measured in such a way that the characteristics reported agree with how the devices will actually perform when incorporated into a system. This measurement is accomplished by mounting the devices on a 40°C heat sink and measuring the device while fully powered.

This method of measurement ensures that Luminus LEDs perform in the field just as they are specified.

Multiple Operating Points

The tables on the following pages provide typical optical and electrical characteristics for the standard drive conditions. Since the LEDs can be operated over a wide range of drive conditions(currents from 200 mA to 18 A, and duty cycle from <1% to 100%) there are many other potential values attainable. Driving devices beyond recommended driving conditions shortens lifetime.

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Ordering Information

Products	Ordering Part Number	Description
CBM-120-UV	CBM-120-UV-C31-FF###-2#	CBM-120 Mosaic Array UV chipset consisting of 12x1mm2 UV LEDs, a thermistor, connectors, and a square copper-core PCB.
	CBM-120-UV-C14-FF###-2#	CBM-120 Mosaic Array UV chipset consisting of 12x1mm2 UV LEDs, connectors, and a slim (rectangular) copper-core PCB.

Part Number Nomenclature

CBM — 120 — CC — C## — FF###-2#

Product Family	Chip Area	Color	Package Configuration	Bin Kit [1,2,3]
CBM: Copper-core PCB, Mosiac Array	120: 12 mm^2	UV = Ultraviolet	C14: 28 mm x 26.75 mm - Slim Package C31: 28 mm x 26.75 mm - Square Package See Mechanical Drawing section	See page 5 for complete bin definition table

Note 1: A Bin Kit represents a group of individual flux or power bins that are shippable for a given ordering part number. Individual flux bins are not orderable..
Note 2: Flux Bin listed is minimum bin shipped - higher bins may be included at Luminus' discretion

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CBT-120-UV Binning Structure

CBM-120-UV LEDs are specified for luminous flux and chromaticity/wavelength at a drive current of 9 A (750 mA/mm2) and placed into one of the following Power Bins and Wavelength Bins:

Power Bins

Color	Power Flux Bin (FF)	Minimum Flux (W)	Maximum Flux (W)
UV	FA	6.0	6.5
	FB	6.5	7.0
	GA	7.0	7.5
	GB	7.5	8.0
	H	8.0	9.1
	I	9.1	10.0
	J	10.0	11.0
	K	11.0	12.1
	L	12.1	13.3

*Note: Luminus maintains a +/- 6% tolerance on power measurements.

Peak Wavelength Bins

Color	Wavelength Bin (###)	Minimum Wavelength (nm)	Maximum Wavelength (nm)
UV	365	365	370
	370	370	375
	375	375	380
	380	380	385
	385	385	390
	390	390	395
	395	395	400
	400	400	405
	405	405	410

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CBM-120 UV Mosaic Array Bin Kits

Wavelength Range	Luminous Flux		Wavelength Bins	Ordering Bin Kit Number
	Bin Kit Flux Code	Min. Flux		
365-375	FA	6.0	365	FA-365-21
			365, 370	FA-365-22
	FB	6.5	365	FB365-21
	GA	7.0	365	GA-365-21
380-390	I	9.1	380	I380-21
			385	I385-21
			380, 385	I380-22
	J	10.0	380	J380-21
			385	J385-21
			380, 385	J380-22
	K	11.0	380	K380-21
			385	K385-21
			380, 385	K380-22
390-400	I	9.1	390	I390-21
			395	I395-21
			390, 395	I390-22
	J	10.0	390	J390-21
			395	J395-21
			390, 395	J390-22
	K	11.0	390	K390-21
			395	K395-21
			390, 395	K390-22
400-410	I	9.1	400	I400-21
			405	I405-21
			400, 405	I400-22
	J	10.0	400	J400-21
			405	J405-21
			400, 405	J400-22
	K	10.0	400	K400-21
			405	K405-21
			400, 405	K400-22

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Reference Optical & Electrical Characteristics (T_{hs} = 40°C)[1,2]

UV						
Parameter	**Symbol**	**Values[3]**				**Unit**
Peak Wavelength Range	λ	365 - 375	380-390	390-400	400-410	nm
Drive Conditions[4]	I	9.0	9.0	9.0	9.0	A
Peak Wavelength Typ.	λ_p	368	384 | 387	393 | 397	403 | 407	nm
Current Density	j	0.75	0.75	0.75	0.75	A/mm²
Forward Voltage	$V_{F\,min}$	3.0	3.0	3.0	3.0	V
	V_F	3.6	3.6	3.6	3.6	V
	$V_{F\,max}$	4.0	4.0	4.0	4.0	V
Radiometric Flux[5]	Φ_{typ}	6.8	10.5	10.5	10.5	W
FWHM at 50% of Φ	$\Delta\lambda_{1/2}$	14	14	14	14	nm

Parameter	**Symbol**	**Values**	**Unit**
Absolute Minimum Current (CW or Pulsed)[6]		0.2	A
Absolute Maximum Current (CW) [7]		365nm - 12 380nm-410nm - 18	A
Absolute Maximum Surge Current [7] (Frequency > 240 Hz, duty cycle =10%, t=1ms)		30	A
Maximum Junction Temperature[8]	T_{jmax}	120	°C
Storage Temperature Range		-40 to +100	°C
Emitting Area		12.9	mm²
Emitting Area Dimensions		4.50 × 3.32	mm × mm

Note 1: Data verified using NIST traceable calibration standard.

Note 2: All data are based on test conditions with a constant heat sink temperature T_{hs} = 40°C under pulse testing conditions. Pulse conditions: 25% duty-cycle, frequency of 720Hz , 3 second soak.

Note 3: Unless otherwise noted, values listed are typical. Devices are production tested and specified at 9 A.

Note 4: Listed drive conditions are typical for common applications. CBM120-UV devices can be driven at currents ranging from 200 mA to 120 A and at duty cycles ranging from 1% to 100%. Drive current and duty cycle should be adjusted as necessary to maintain the junction temperature desired to meet application lifetime requirements.

Note 5: Typical total flux from emitting area at listed peak wavelength. Reported performance is included to show trends for a selected power level. For specific minimum and maximum values, use bin tables. For product roadmap and future performance of devices, contact Luminus.

Note 6: Special design considerations must be observed for operation under 1 A. Please contact Luminus for further information.

Note 7: CBM-120-UV LEDs are designed for operation to an absolute maximum current as specified above. Product lifetime data is specified at recommended forward drive currents. Sustained operation at or beyond absolute maximum currents will result in a reduction of device life time compared to recommended forward drive currents. Actual device lifetimes will also depend on junction temperature. Refer to the lifetime derating curves for further information. In pulsed operation, rise time from 10-90% of forward current should be longer than 0.5 µseconds.

Note 8: Lifetime dependent on LED junction temperature. Input power and thermal system must be properly managed to ensure lifetime.

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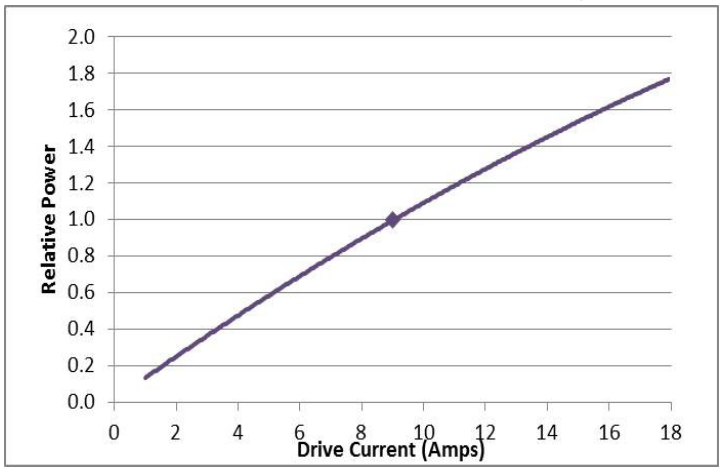
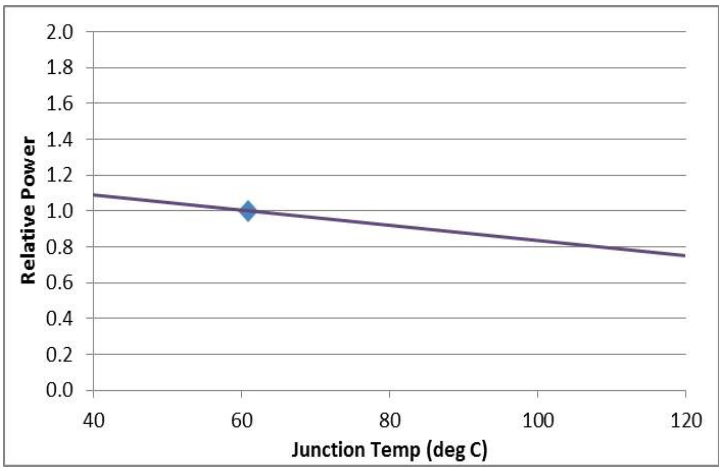
Optical & Electrical Characteristics

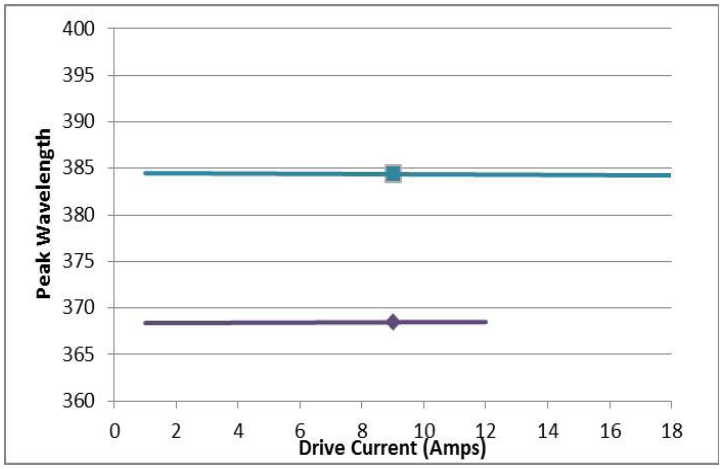
Relative Power vs Forward Current, T_j = 60°C



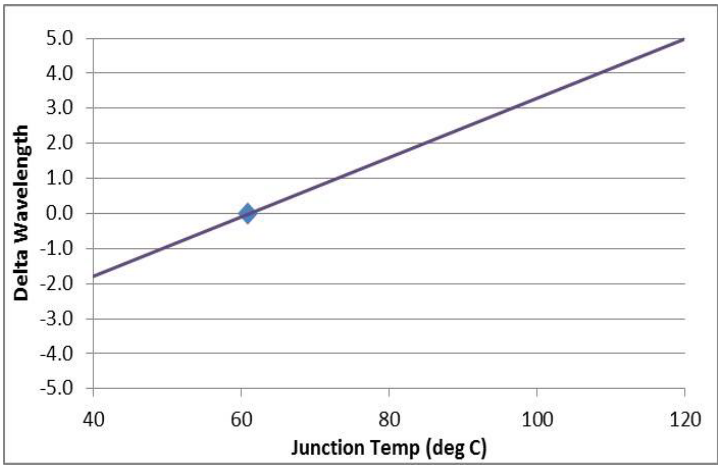
Relative Power vs Junc. Temperature, I_f = 9 A



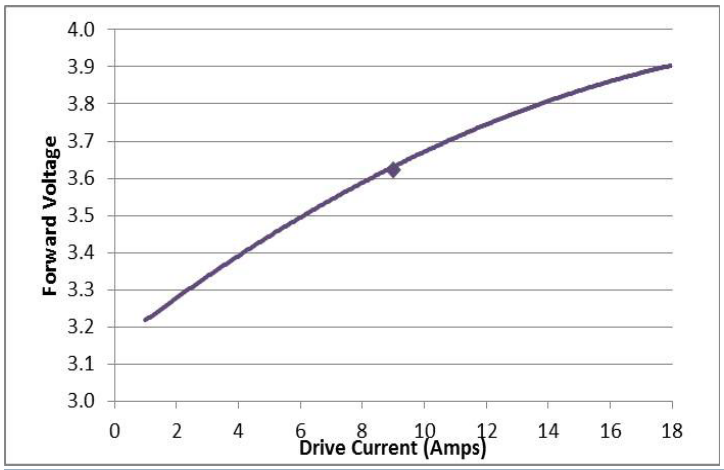
Peak Wavelength vs Forward Current



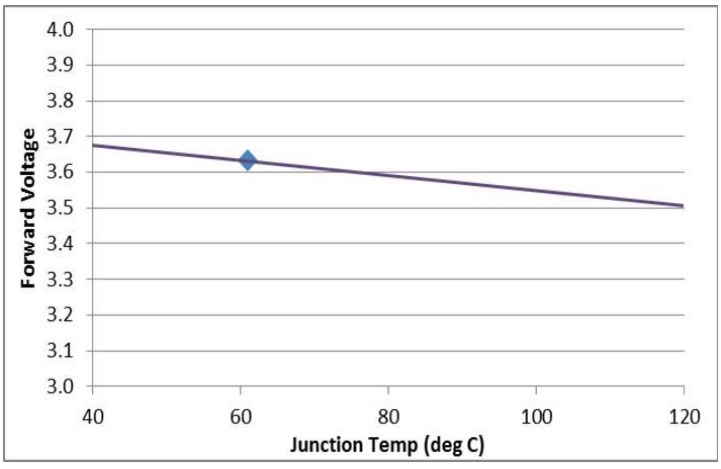
Peak Wavelength vs Junction Temperature



Forward Voltage vs Forward Current



Forward Voltage vs Junction Temperature



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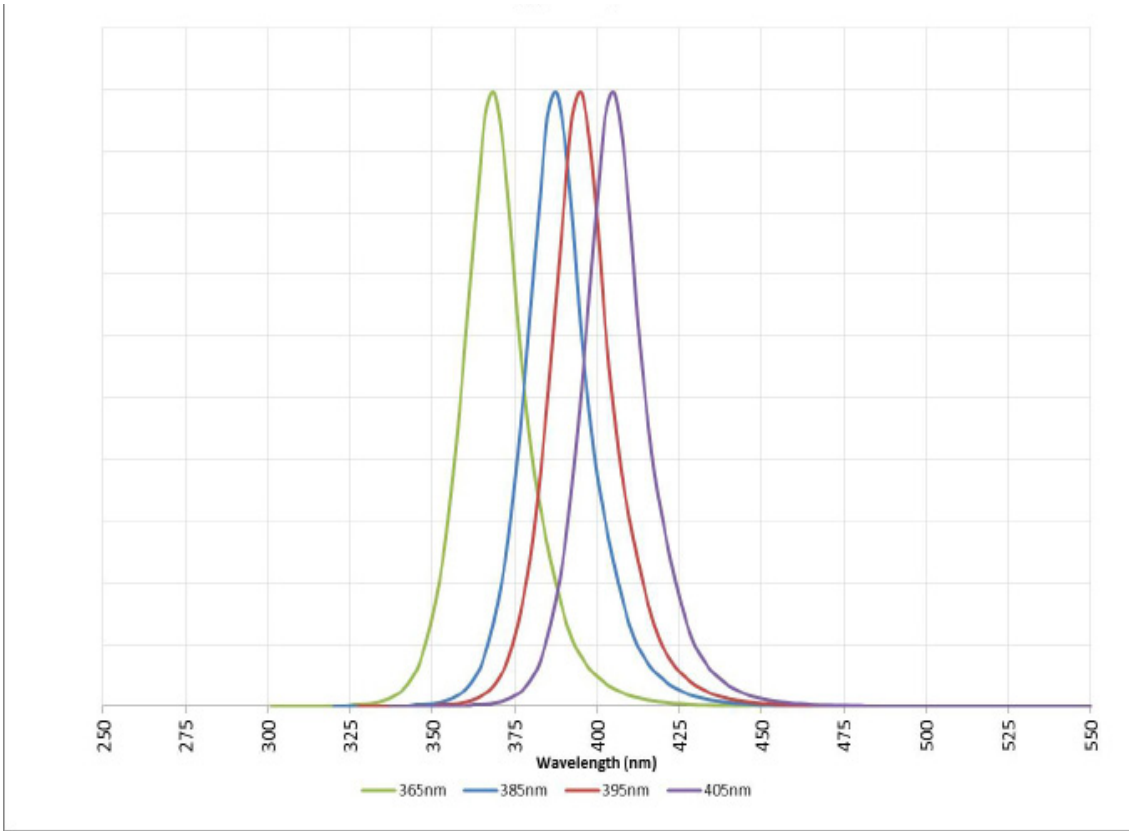
Typical Spectrum[9]



Note 9: Typical spectrum at current of 9 A in continuous operation.

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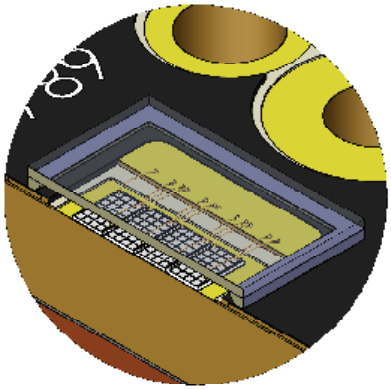
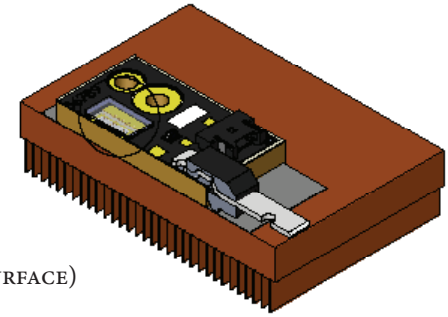
Thermal Resistance CBM-120-UV

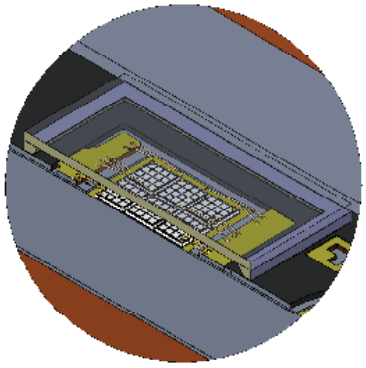


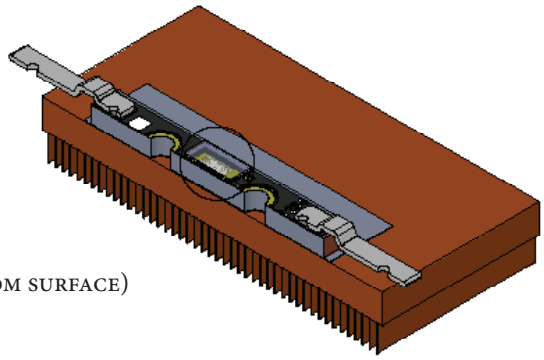


TJ = Die Junction Temp
TB = Coreboard Temp
THS = Heatsink Temp (3mm from surface)
TREF - Thermistor Temp

Typical Thermal Resistance[1] - C31

$R_{\theta j\text{-}b}$[2]	0.61 °C/W
$R_{\theta b\text{-}hs}$[3]	0.12 °C/W
$R_{\theta j\text{-}hs}$[3]	0.73 °C/W
$R_{\theta j\text{-}ref}$[2]	0.64 °C/W





TJ = Die Junction Temp
TB = Coreboard Temp
THS = Heatsink Temp (3mm from surface)

Typical Thermal Resistance[1] - C14

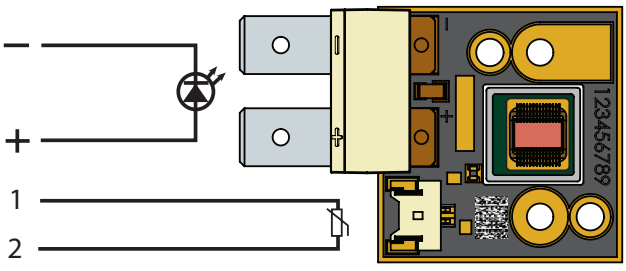
$R_{\theta j\text{-}b}$[2]	0.76 °C/W
$R_{\theta b\text{-}hs}$[3]	0.12 °C/W
$R_{\theta j\text{-}hs}$[3]	0.88 °C/W

Note 1: Real thermal resistance data - "Electrical" thermal resistance values available upon request

Note 2: Thermal resistance values are based on measured wavelength shift data.

Note 3: Thermal Resistance is based on eGraf 1205 Thermal interface.

Electrical Pinout - C31 Package



The thermistor used in CBT-120 devices mounted on coreboards is from Murata Manufacturing Co. The global part number is NCP18XH103J03RB. Please see http://www.murata.com/ for details on calculating thermistor temperature.

For more information on use of the thermistor, please contact Luminus directly.

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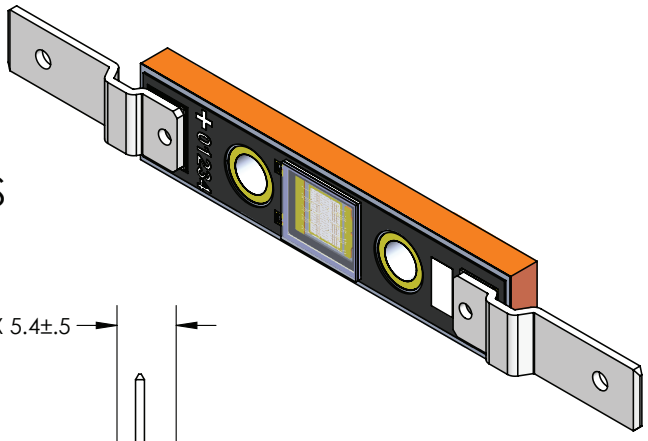
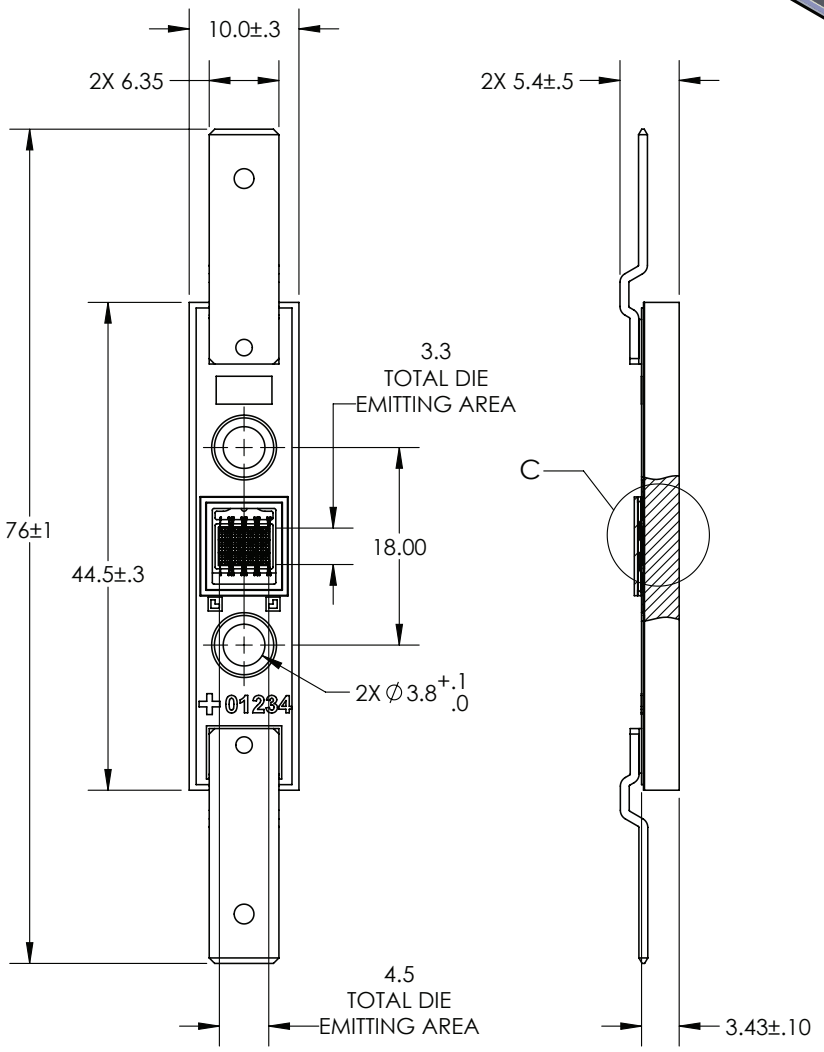
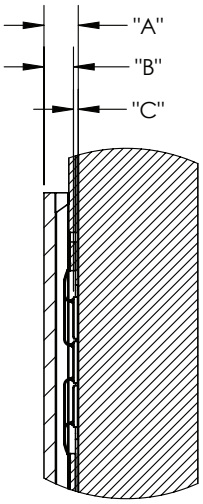
Mechanical Dimensions – CBM-120-UV-C14 Mosaic Array LED Emitter



DIMENSIONS IN MILLIMETERS





DETAIL C

DIMENSION NAME	DESCRIPTION	NOMINAL DIMENSION	TOLERANCE
"A"	TOP OF METAL SUBSTRATE TO TOP OF WINDOW	.91	±.13
"B"	TOP OF DIE EMITTING AREA TO TOP OF WINDOW	.78	±.11
"C"	TOP OF METAL SUBSTRATE TO TOP OF DIE EMITTING AREA	.13	±.02

DWG-002534

Recommended connector for Anode and Cathode: Panduit Disco Lok™ Series P/N: DNG14-250FL-C.

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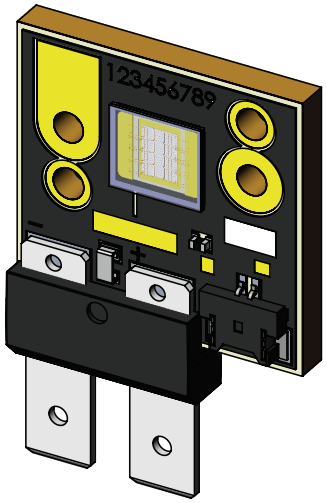
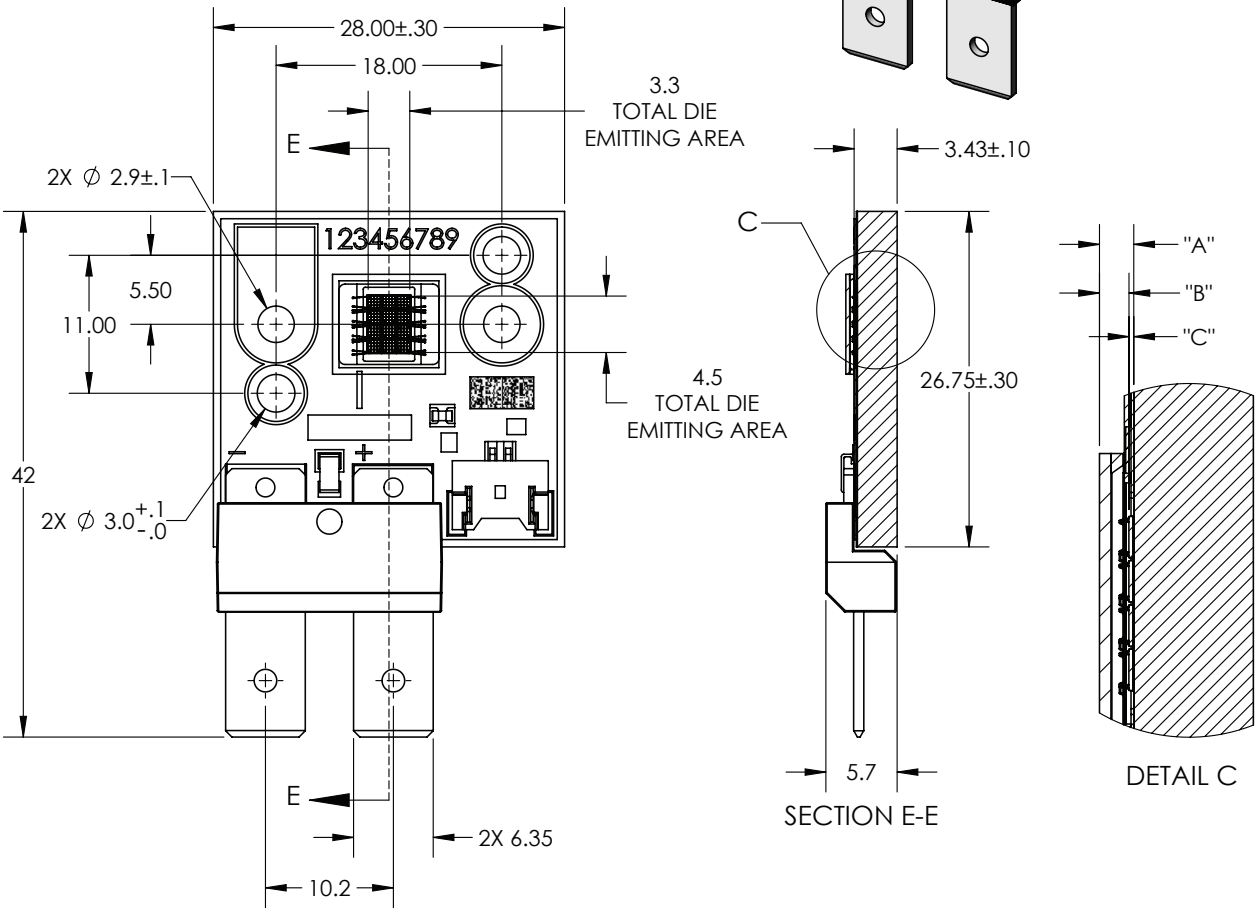
Mechanical Dimensions – CBM-120-UV-C31 Mosaic Array LED Emitter



DIMENSIONS IN MILLIMETERS



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"C"	TOP OF METAL SUBSTRATE TO TOP OF DIE EMITTING AREA	.13	±.02

DWG-002558

Recommended connector for Anode and Cathode: Panduit Disco Lok™ Series P/N: DNG14-250FL-C.
Thermistor Connector: MOLEX P/N 53780-0270 or GCT P/N WTB08-021S-F.
Recommended Female: MOLEX P/N 51146-0200, GCT P/N WTB06-021S-F or equivalent

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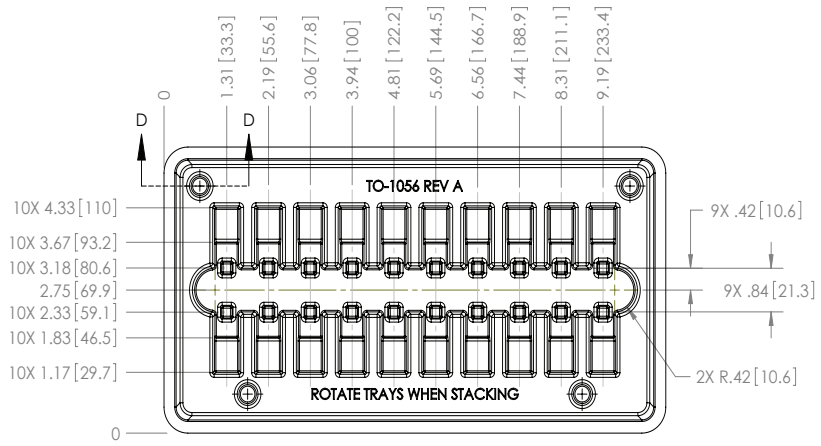
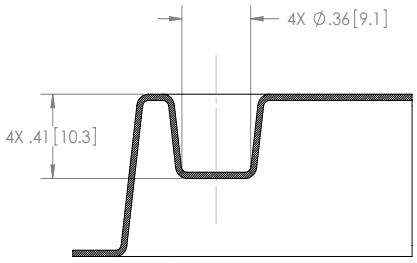
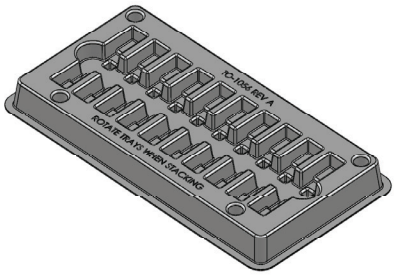
Shipping Tray Outline - CBM-120-C14





SECTION D-D
SCALE 2 : 1



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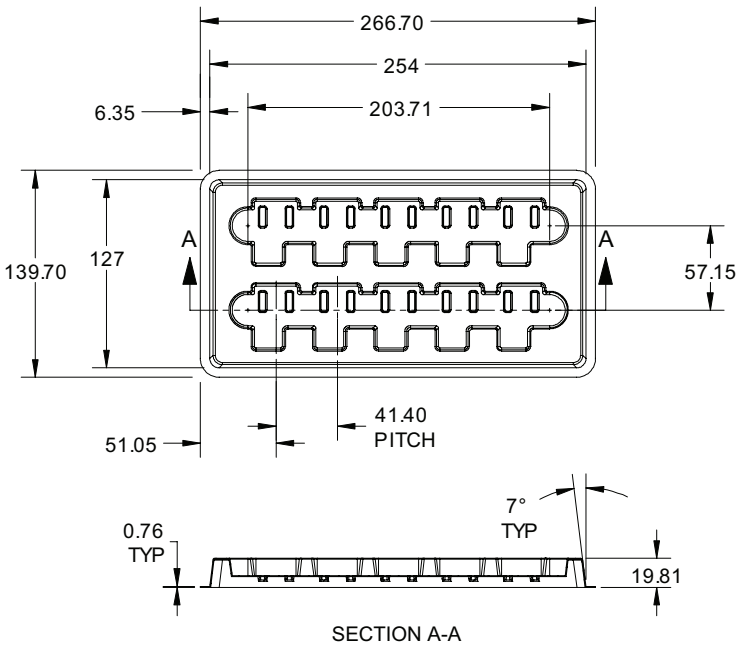
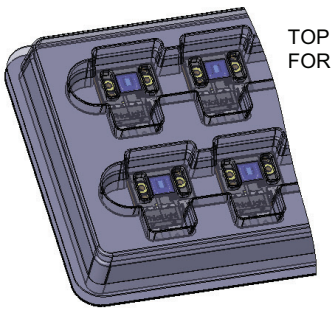
Shipping Tray Outline - CBM-120-C31

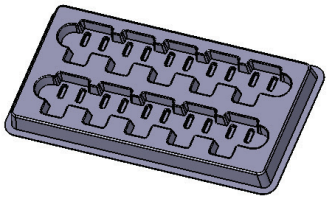
DIMENSIONS IN MILLIMETERS



SECTION A-A



TOP TRAY SHOWN TRANSPARENT
FOR REFERENCE ONLY



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Packing and Shipping Specification (CBM-120)

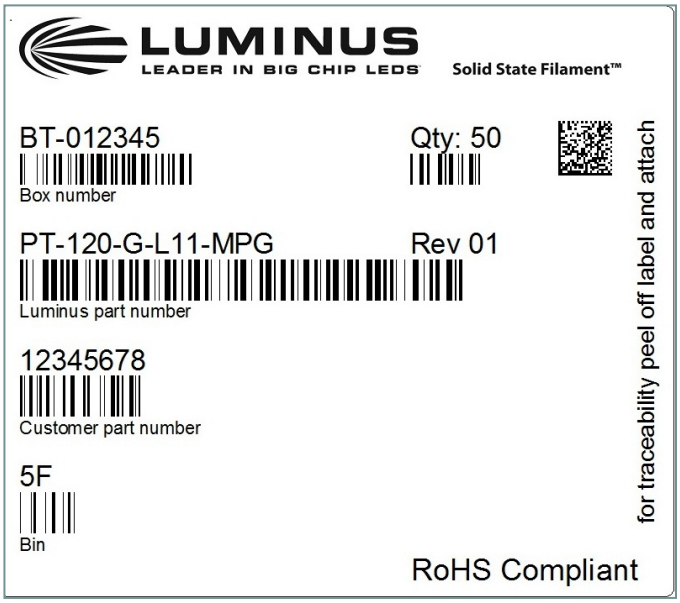
Packing Specification

Packing Configuration	Qty /Pack	Reel Dimensions (diameter x W, mm)	Gross Weight (kg)
Stack of 5 trays with 10 devices per tray Each pack is enclosed in ESD bag	50	150 x 280 x 85	2.7

Product Label Specification

Label Fields (subject to change):

- 6-8 digit Box number (for Luminus internal use)
- Luminus ordering part number
- Quantity of devices in pack
- Part number revision (for Luminus internal use)
- Customer's part number (optional)
- Flux Bin
- 2D Bar code



Sample label –for illustration only

Shipping Box

Shipping Box	Quantity	Material	Dimensions (L x W x H, mm)
Carton Box	1 -20 packs (50 - 1000 Devices)	S4651	560 x 560 x 200

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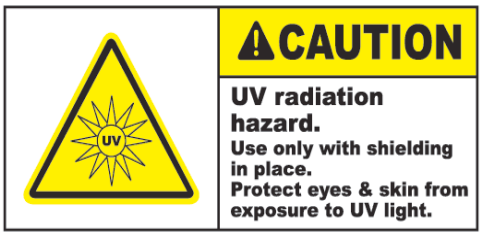
History of Changes

Rev		Description of Change
A	01/09/2015	Initial Release - Preliminary Specifications for 365nm and 380nm CBM-120 Parts
B	04/03/2015	Added Data for 390nm and 400nm CBM-120 Parts, Updated binning structure



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AMEYA360
Components Supply Platform

Authorized Distribution Brand :

Website :

Welcome to visit www.ameya360.com

Contact Us :

- ### Address :

  401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd
  Minhang District, Shanghai , China

- ### Sales :

  Direct +86 (21) 6401-6692

  Email amall@ameya360.com

  QQ 800077892

  Skype ameyasales1 ameyasales2

- ### Customer Service :

  Email service@ameya360.com

- ### Partnership :

  Tel +86 (21) 64016692-8333

  Email mkt@ameya360.com